

Features

Application

Switching

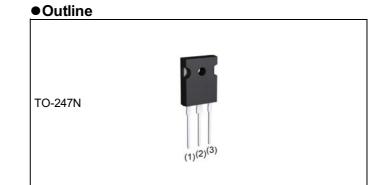
1) Low on - resistance

2) High power small mold package

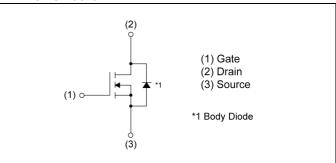
3) Pb-free lead plating ; RoHS compliant

Nch 60V 180A Power MOSFET

V _{DSS}	60V
R _{DS(on)} (Max.)	3.4mΩ
Ι _D	±180A
P _D	166W



Inner circuit



Packaging specifications

	aonaging opportionationo				
	Packing	Tube			
Turne	Quantity (pcs)	450			
Туре	Taping code	C11			
	Marking	RZ2L18CGN			

• Absolute maximum ratings (T_a = 25°C ,unless otherwise specified)

Parameter	Symbol	Value	Unit	
Drain - Source voltage		V _{DSS}	60	V
Continuous drain current	V _{GS} = 10V	I _D *1	±180	А
Pulsed drain current	^{*2}	±360	А	
Gate - Source voltage		V _{GSS}	±20	V
Avalanche current, single pulse		I _{AS} *3	40	А
Avalanche energy, single pulse		E_{AS}^{*3}	61	mJ
Power dissipation		P _D ^{*1}	166	W
Junction temperature		Tj	150	C°
Operating junction and storage tempe	T _{stg}	-55 to +150	°C	

•Thermal resistance

Parameter	Symbol	Values			Linit
Farameter	Symbol	Min.	Тур.	Max.	Unit
Thermal resistance, junction - case	R_{thJC}^{*1}	-	-	0.75	°C/W

•Electrical characteristics (T_a = 25°C)

Deremeter	Currente e l	Symbol		Values		
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Drain - Source breakdown voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 1mA	60	-	-	V
Breakdown voltage temperature coefficient	$\frac{\Delta V_{(BR)DSS}}{\Delta T_j}$	I _D = 1mA referenced to 25°C	-	60	-	mV/°C
Zero gate voltage drain current	I _{DSS}	V _{DS} = 60V, V _{GS} = 0V	-	-	5	μA
Gate - Source leakage current	I _{GSS}	V_{GS} = ±20V, V_{DS} = 0V	-	-	±500	nA
Gate threshold voltage	V _{GS(th)}	V_{DS} = V_{GS} , I_D = 200 μ A	1.0	-	2.5	V
Gate threshold voltage temperature coefficient	$\frac{\Delta V_{GS(th)}}{\Delta T_j}$	I _D = 1mA referenced to 25°C	-	-5.6	-	mV/°C
Static drain - source on - state resistance	R _{DS(on)} *4	V _{GS} = 10V, I _D = 40A	-	2.5	3.4	mΩ
Gate resistance	R _G	f = 1MHz, open drain	-	1.5	-	Ω
Forward Transfer Admittance	Y _{fs} ^{*4}	V _{DS} = 5V, I _D = 90A	55	-	-	S

*1 Tc=25°C, Limited only by maximum temperature allowed.

*2 Pw \leq 10µs , Duty cycle \leq 1%

*3 L \simeq 0.05mH, V_{DD} = 30V, R_G = 25 Ω , Starting T_i = 25°C Fig.3-1,3-2

*4 Pulsed



• Electrical characteristics ($T_a = 25^{\circ}C$)

Parameter	Sumbol	Conditions	Values			Unit
	Symbol	Conditions	Min.	Тур.	Max.	Unit
Input capacitance	C _{iss}	V _{GS} = 0V	-	7100	-	
Output capacitance	C _{oss}	V _{DS} = 30V	-	1380	I	pF
Reverse transfer capacitance	C _{rss}	f = 1MHz	-	350	I	
Turn - on delay time	$t_{d(on)}^{*4}$	$V_{DD} \simeq 30V, V_{GS} = 10V$	-	33	-	
Rise time	t _r *4	I _D = 50A	-	48	I	no
Turn - off delay time	$t_{d(off)}^{*4}$	$R_L \simeq 0.6\Omega$	-	180	-	ns
Fall time	t _f *4	R _G = 10Ω	-	250	-	

• Gate charge characteristics ($T_a = 25^{\circ}C$)

Deremeter	Sumbol	Conditions		Values			Linit
Parameter	Symbol	Conditi	Conditions		Тур.	Max.	Unit
Total gata charge	O *4		V _{GS} = 10V	-	139	-	
Total gate charge	Q _g ·	Q_g^{*4} $V_{DD} \simeq 30V$		-	74	-	-0
Gate - Source charge	Q _{gs} *4	I _D = 50A	V _{GS} = 4.5V	-	30	-	nC
Gate - Drain charge	Q_{gd}^{*4}			-	27	-	

•Body diode electrical characteristics (Source-Drain) (T_a = 25°C)

Deremeter	Sumbol	ol Conditions		Values		
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Continuous forward current	I _S	T - 25°0	-	-	138	А
Pulse forward current	I _{SP} ^{*2}	T _a = 25°C	-	-	360	А
Forward voltage	V _{SD} ^{*4}	V _{GS} = 0V, I _S = 40A	-	-	1.2	V





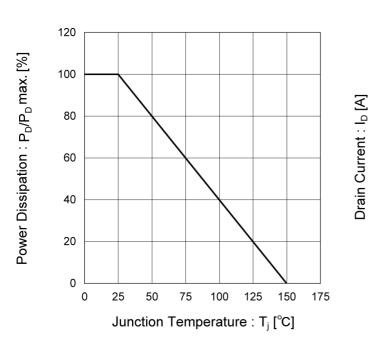


Fig.1 Power Dissipation Derating Curve

Fig.2 Maximum Safe Operating Area

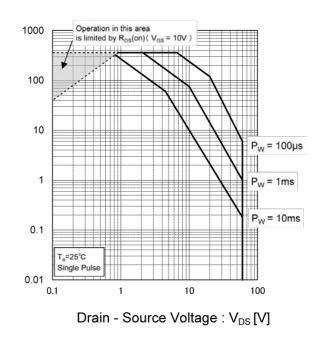
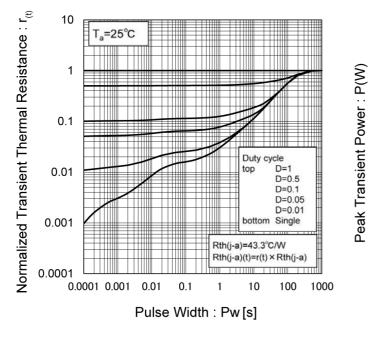
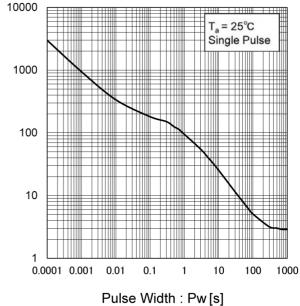


Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width

Fig.4 Single Pulse Maximum Power dissipation







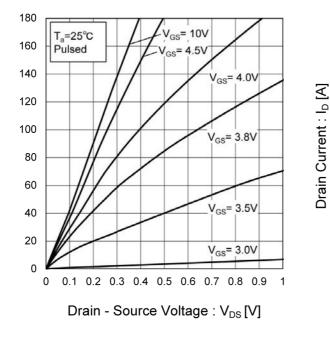


Fig.5 Typical Output Characteristics(I)

Fig.6 Typical Output Characteristics(II)

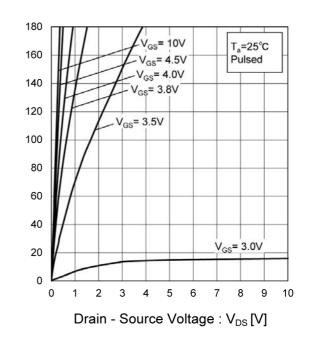


Fig.7 Breakdown Voltage vs. Junction Temperature

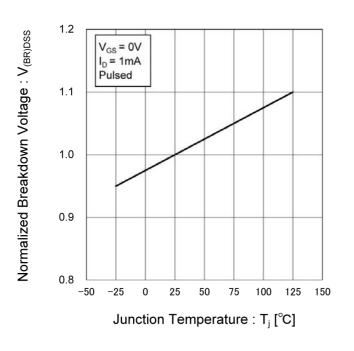






Fig.8 Typical Transfer Characteristics

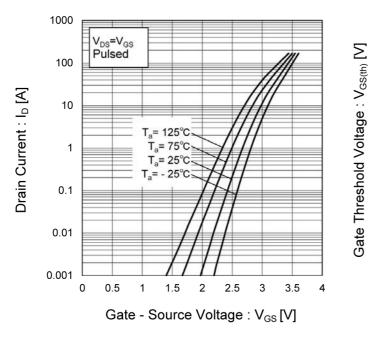


Fig.9 Gate Threshold Voltage vs. Junction Temperature

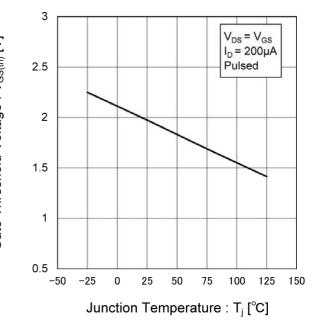
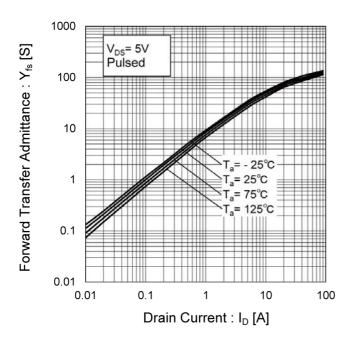


Fig.10 Forward Transfer Admittance vs. Drain Current





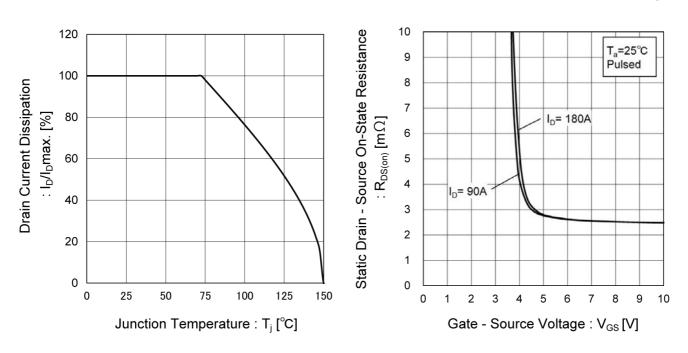
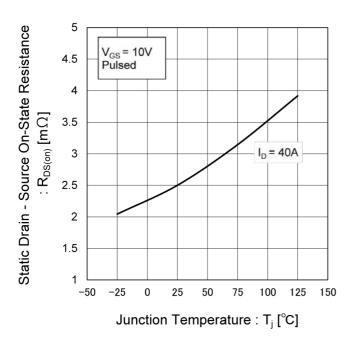


Fig.11 Drain Current Derating Curve

Fig.12 Static Drain - Source On - State Resistance vs. Gate Source Voltage

Fig.13 Static Drain - Source On - State Resistance vs. Junction Temperature





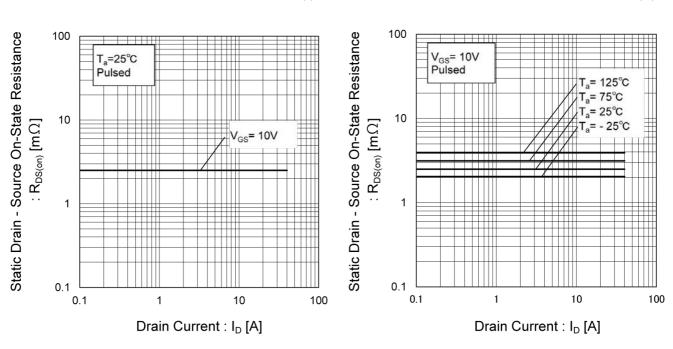


Fig.15 Static Drain - Source On - State Resistance vs. Drain Current (II)





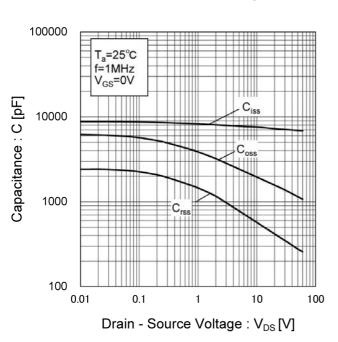


Fig.16 Typical Capacitance vs. Drain - Source Voltage

Fig.17 Switching Characteristics

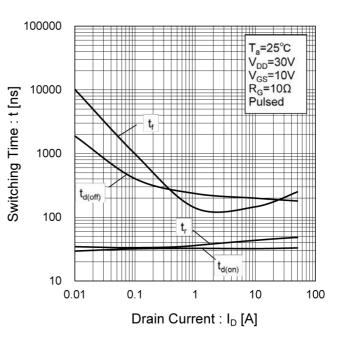


Fig.18 Dynamic Input Characteristics

Gate - Source Voltage : V_{GS} [V]

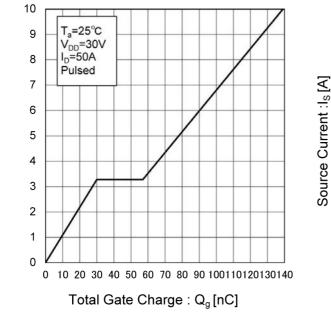
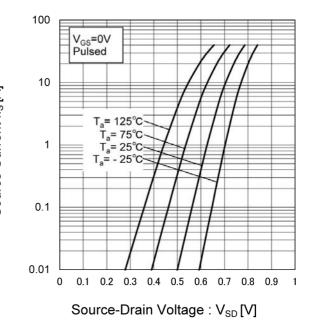


Fig.19 Source Current vs. Source Drain Voltage





Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

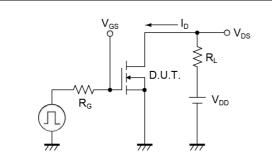


Fig.2-1 Gate Charge Measurement Circuit

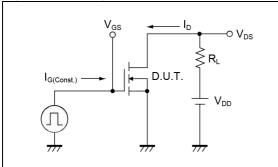


Fig.3-1 Avalanche Measurement Circuit

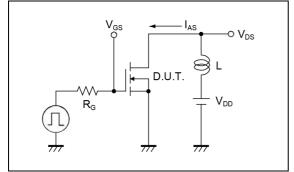


Fig.1-2 Switching Waveforms

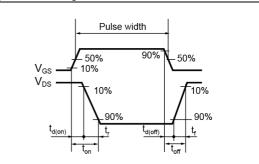


Fig.2-2 Gate Charge Waveform

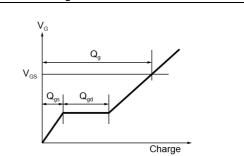
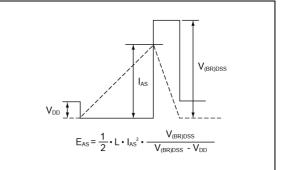
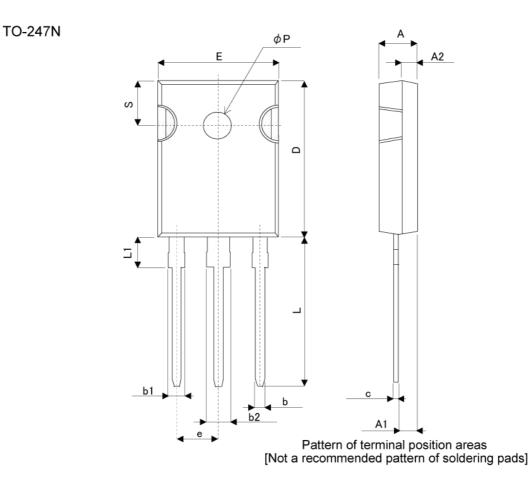


Fig.3-2 Avalanche Waveform





Dimensions



DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
A	4.80	5.20	0.189	0.205
A1	2.10	2.70	0.083	0.106
A2	1.80	2.20	0.071	0.087
b	1.00	1.40	0.039	0.055
b1	1.90	2.30	0.075	0.091
b2	2.90	3.30	0.114	0.130
с	0.45	0.75	0.018	0.030
D	20.70	21.30	0.815	0.839
E	15.70	16.30	0.618	0.642
е	5.4	45	0.2	15
L.	19.70	20.30	0.776	0.799
L1	3.80	4.20	0.150	0.165
Р	3.50	3.70	0.138	0.146
S	5.80	6.20	0.228	0.244

Dimension in mm/inches



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(Note1) Medical Equipment Classification of the Specific Applications

JAPAN	USA	EU	CHINA
CLASSⅢ	CLASSI	CLASS II b	CLASSII
CLASSⅣ	CLASSII	CLASSⅢ	CLASSI

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 - [b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure
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 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- 2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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RZ2L18CGN - Web Page

Part Number	RZ2L18CGN
Package	TO-247
Unit Quantity	450
Minimum Package Quantity	30
Packing Type	Tube
Constitution Materials List	inquiry
RoHS	Yes